# **35 V, 5 A, Low V<sub>CE(sat)</sub> PNP Transistor**

ON Semiconductor's e<sup>2</sup>PowerEdge family of low  $V_{CE(sat)}$  transistors are miniature surface mount devices featuring ultra low saturation voltage ( $V_{CE(sat)}$ ) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical application are DC–DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e<sup>2</sup>PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

#### Features

- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These are Pb-Free Devices\*

Rating	Symbol	Мах	Unit		
Collector-Emitter Voltage	V <sub>CEO</sub>	-35	Vdc		
Collector-Base Voltage	V <sub>CBO</sub>	-55	Vdc		
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	Vdc		
Collector Current – Continuous	۱ <sub>C</sub>	-2.0	Adc		
Collector Current – Peak	I <sub>CM</sub>	-5.0	А		
Electrostatic Discharge	ESD	HBM Class 3 MM Class C			

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



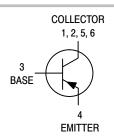
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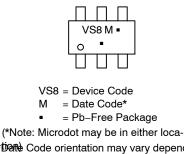
# $\begin{array}{l} 35 \text{ VOLTS} \\ 5.0 \text{ AMPS} \\ \\ \text{PNP LOW } V_{\text{CE(sat)}} \text{ TRANSISTOR} \\ \\ \text{EQUIVALENT } R_{\text{DS(on)}} \text{ 100 } \text{m}\Omega \end{array}$



CASE 318G STYLE 6



#### MARKING DIAGRAM



\*Date Code orientation may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NSS35200MR6T1G	TSOP-6 (Pb-Free)	3,000 / Tape & Reel
SNSS35200MR6T1G	TSOP-6 (Pb-Free)	3,000 / Tape & Reel

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### **THERMAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
Total Device Dissipation T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub> (Note 1)	625 5.0	MW mW/°C
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub> (Note 1)	200	°C/W
Total Device Dissipation T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub> (Note 2)	1.0 8.0	W mW/°C
Thermal Resistance, Junction-to-Ambient	R <sub>0JA</sub> (Note 2)	120	°C/W
Thermal Resistance, Junction-to-Lead #1	R <sub>θJL</sub>	80	°C/W
Total Device Dissipation (Single Pulse < 10 sec.)	P <sub>Dsingle</sub> (Notes 2 & 3)	1.75	W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C

FR-4 @ Minimum Pad.
FR-4 @ 1.0 X 1.0 inch Pad.
Refer to Figure 8.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typical	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage ( $I_C = -10 \text{ mAdc}, I_B = 0$ )	V <sub>(BR)CEO</sub>	-35	-45	-	Vdc
Collector – Base Breakdown Voltage $(I_{C} = -0.1 \text{ mAdc}, I_{E} = 0)$	V <sub>(BR)CBO</sub>	-55	-65	-	Vdc
Emitter – Base Breakdown Voltage (I <sub>E</sub> = –0.1 mAdc, I <sub>C</sub> = 0)	V <sub>(BR)EBO</sub>	-5.0	-7.0	-	Vdc
Collector Cutoff Current (V <sub>CB</sub> = -35 Vdc, I <sub>E</sub> = 0)	I <sub>CBO</sub>	_	-0.03	-0.1	μAdc
Collector–Emitter Cutoff Current (V <sub>CES</sub> = –35 Vdc)	ICES	_	-0.03	-0.1	μAdc
Emitter Cutoff Current (V <sub>EB</sub> = -4.0 Vdc)	I <sub>EBO</sub>	_	-0.01	-0.1	μAdc
ON CHARACTERISTICS					
DC Current Gain (Note 4) ( $I_C = -1.0 \text{ A}, V_{CE} = -1.5 \text{ V}$ ) ( $I_C = -1.5 \text{ A}, V_{CE} = -1.5 \text{ V}$ ) ( $I_C = -2.0 \text{ A}, V_{CE} = -3.0 \text{ V}$ )	h <sub>FE</sub>	100 100 100	200 200 200	400 -	
Collector – Emitter Saturation Voltage (Note 4) ( $I_C = -0.8 \text{ A}, I_B = -0.008 \text{ A}$ ) ( $I_C = -1.2 \text{ A}, I_B = -0.012 \text{ A}$ ) ( $I_C = -2.0 \text{ A}, I_B = -0.02 \text{ A}$ )	V <sub>CE(sat)</sub>	- - -	-0.125 -0.175 -0.260	-0.15 -0.20 -0.31	V
Base – Emitter Saturation Voltage (Note 4) ( $I_c = -1.2 \text{ A}, I_B = -0.012 \text{ A}$ )	V <sub>BE(sat)</sub>	_	-0.68	-0.85	V
Base – Emitter Turn–on Voltage (Note 4) ( $I_C = -2.0 \text{ A}, V_{CE} = -3.0 \text{ V}$ )	V <sub>BE(on)</sub>	_	-0.81	-0.875	V
Cutoff Frequency (I <sub>C</sub> = –100 mA, V <sub>CE</sub> = –5.0 V, f = 100 MHz)	f <sub>T</sub>	100	-	-	MHz
nput Capacitance (V <sub>EB</sub> = -0.5 V, f = 1.0 MHz)	Cibo	_	600	650	pF
Dutput Capacitance (V <sub>CB</sub> = -3.0 V, f = 1.0 MHz)	Cobo	_	85	100	pF
				1	1

t<sub>on</sub>

t<sub>off</sub>

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35

225

nS

nS

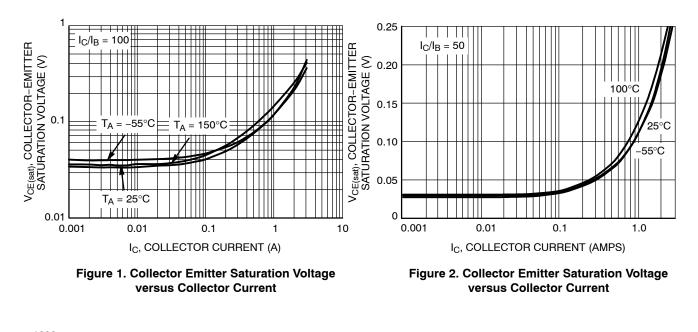
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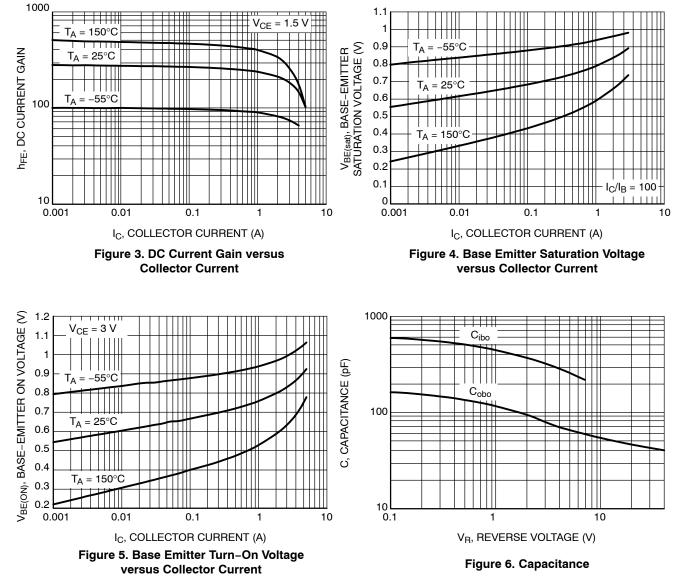
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4. Pulsed Condition: Pulse Width = 300  $\mu$ sec, Duty Cycle  $\leq$  2%.

Turn–on Time (V\_{CC} = –10 V, I\_{B1} = –100 mA, I\_{C} = –1 A, R\_{L} = 3  $\Omega)$ 

Turn-off Time (V\_{CC} = –10 V, I\_{B1} = I\_{B2} = –100 mA, I\_C = 1 A, R\_L = 3  $\Omega)$ 





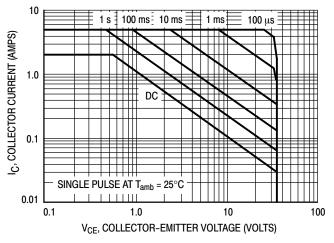


Figure 7. Safe Operating Area

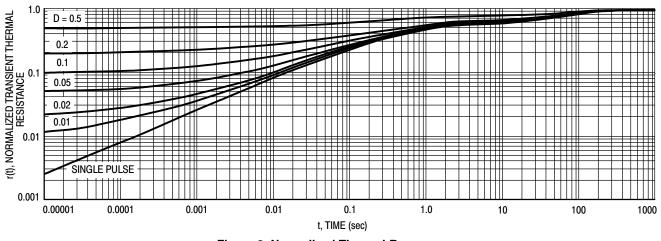
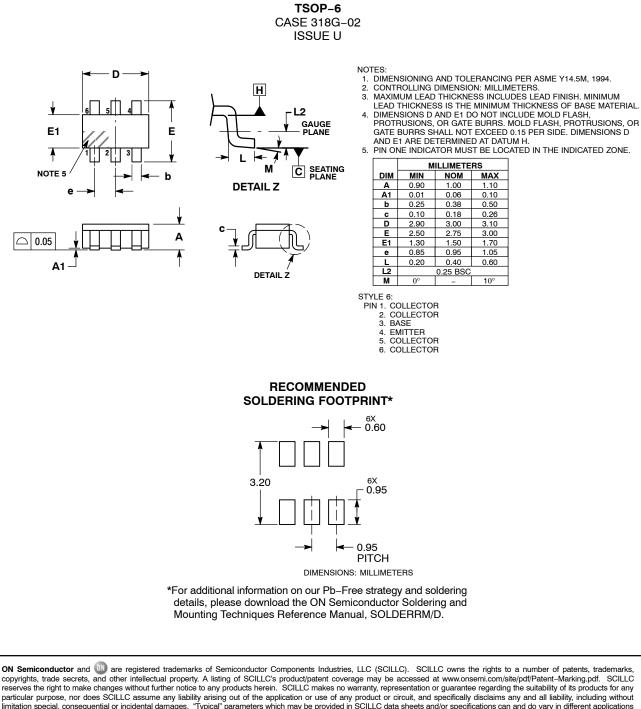


Figure 8. Normalized Thermal Response

#### PACKAGE DIMENSIONS



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